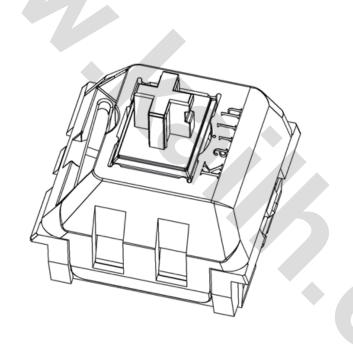




Document Number:

KH-PS1707-28

Product Specification



P/N:

CPG151101D222

Title:

PG1511 Keyboard Switch



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1. Scope:

This Product Specification covers the requirement of Mechanical Keyboard switch on product performance, test methods and quality assurance provisions.

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2. Product Application:

Mainly applied on computer keyboards, cash registers, industrial equipment and Man-Machine interface.

3. Technology Parameters:

Ambient Humidity: 45 ~ 85% RH

Operating Temperature Range: -10°C ~ +70°C Storage Temperature Range: -20°C ~ +70°C Suggested storage period: about 6 months

Require the tin part on the switch terminals should keep good after storage guarantee date

Normal Condition:

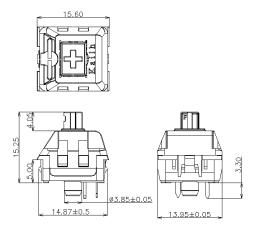
Ambient temperature: 20±2°C Relative humidity: 65%±5%RH Air pressure: 86~101KPa

4. Ratings

Rating: 12V AC/DC max. 2V DC min

10mA AC/DC max. 10μA DC min Insulation Resistance: ≥100MΩ/DC 100V Withstand Voltage: 100 AC 1 Minute Mechanical Life: 70,000,000 Cycles

5. Profile Dimensions





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6. Electrical Performance

Item	Description	Test Condition	Requirement
6.1	Contact Resistance	Static load: (Operation force)x2, which is applied on the center of Switch stem. Measurement tool: Contact resistance Meter. (1KHz,20mV,5~50mA) Measured at low current (100mA or less).	100mΩ Max
6.2	Insulation Resistance	Apply a Voltage of DC 500 V for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body.	100mΩ Min
6.3	Dielectric withstanding voltage	Apply a Voltage of AC100 V (50~60Hz) for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body.	No evidence of breakdown
6.4	Bouncing	Operation speed: 3~4 times/s Oscillo scope Switch Bouncing Test Circuit D. C. 10V 10mA 10K \(\Omega \) Switch Bouncing Test Circuit "ON" "OFF"	Before Life cycle: On: 5ms MAX Off: 5ms MAX After Life cycle: On: 10ms MAX Off: 10ms MAX



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7. Mechanical Performance

Item	Description	Test Condition	Requirement
7.1	Load Curve	Place the vertical direction of switch operation and gradually increase the load applied to the center of the stem until it stop. Force-Travel-diagram 120 100 80 pressure point 60 40 20 Travel (mm) Travel (mm)	See page 11
7.2	Loading parameter	Place the vertical direction of switch operation and gradually increase the load applied to the center of the stem until it stop. Mounting Surface	See page 11

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7.3	Static Strength	A static load of 3kgf shall be applied in the direction of button operation for a period of 60 seconds.	No damage (Electrical) And mechanical
7.4	Stem Pull Strength	Break by a pull force applied opposite to the direction of stem operation.	5kgf Min
7.5	Shock	Measured by according to the below condition: (1) Acceleration: 80g (2) Cycles of test: 3 cycles each in 6 directions, for a total of 18 cycles.	Shall meet No.6, 7.1, 7.2.
7.6	Life Test	1) D.C.12V 10mA resistance load 2) Operation speed: 5-6 times / s 3) Push force: 150gf 4) Push travel: 3.6mm 5) Operation number: 70,000,000 cycles	Contact resistance: 1000 mΩ Max Bouncing: 10ms Max Operation force: Variation rate within ±30%



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8. Environmental Performance

Item	Description	Test Condition	Requirement
8.1	Cold test	 (1) Temperature: -20±2°C (2) Duration of test: 48h (3) Take off a drop water (4) Standard conditions after test: 1h 	Contact resistance: 200mΩ Max Shall meet: No. 6.2 to 6.4 No. 7.1 to 7.2
8.2	Heat test	 (1) Temperature: 70±2°C (2) Duration of test: 48h (3) Take off a drop water (4) Standard conditions after test: 1h 	Contact resistance: 200mΩ Max Shall meet: No. 6.2 to 6.4 No. 7.1 to 7.2
8.3	Temperature cycle	(1) Test cycles: 5 cycles (2) Standard condition after test: 1h Temperature Duration of test 20±5°C 1h -20±2°C 1h 20±5°C 1h 70±5°C 1h	Contact resistance: 200mΩ Max Shall meet: No. 6.2 to 6.4 No. 7.1 to 7.2

Product Specification Kailh Rev.: P/N: DOC. No.: Page: **KAIHUA ELECTRONICS** 8/11 CPG151101D222 KH-PS1707-28 Soldering area: T/2 of PWB thickness. (PWB: T=1.6mm) Soldering Appearance: 8.4 Soldering temperature: 260±5°C No abnormality. heat test Soldering time: 5±0.5s 1. Hand soldering: Please practice according to below condition: (1) Soldering Temperature: 350±5°C (2) Continual soldering time: 3±0.5s (3) Capacity of soldering iron: ≤20w 2. Automatic PIP soldering: At least 95% of surface area For the product of T/H according to below of immersed portion shall be condition: 8.5 Solder ability covered by solder. Wave Soldering Temperature Curve (Single Wave Peak) 200



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8.6	Humidity test	(2) relative humidity: 90~95% R.H. (3) Duration of test: 48h (4) Take off a drop water		Humidity (2) relative humidity: 90~95% R.H. (3) Duration of test: 48h (4) Take off a drop water (2) relative humidity: 90~95% R.H. Shall meet: No. 6.2 to 6.4		::	
8.7	Salt Spray	Apply the following environment to test: (1) Temperature: 35±5°C (2) Salt water density: 5±1% (3) Duration: 12hours (4) After test, the salt deposit shall be removed by running water.				sion spot, plate nake Resistanc	
8.8	Withstand K₂S	Apply the following environment to test: (1) Temperature: 35±5°C (2) K2S Density: 2% (3) Duration: 2 minute.		Appearar No corros crack, no naked. Contact I 1000 mΩ	sion spot, base pla Resistanc	te	



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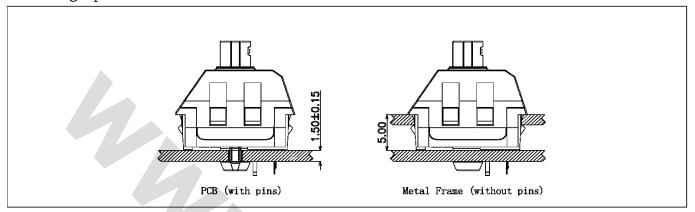
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9. Recommended PCB Layout

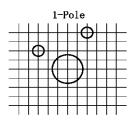
Mounting Options

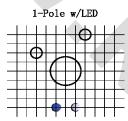


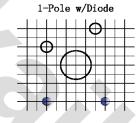
Circuit Board Layouts

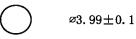
Grid line spacing = 1.27mm

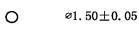
Keyswitch without fixation pins





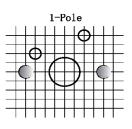


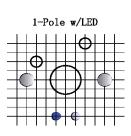


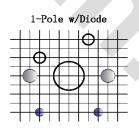


● Ø1.0±0.1

Keyswitch with fixation pins









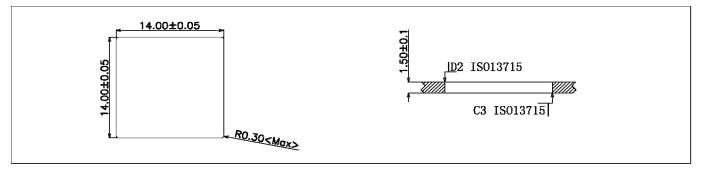


Ø1.70±0.05

ø1.50±0.05

Ø1.0±0.1

Metal Frame Cutout Dimensions





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10. Loading Parameter (FP/OP/PT/OT /MD/CF/OF) Specification

Parameter	Unit	Specification	Remark
FP	mm	15.25 ± 0.2	
OP	mm	13.55 ± 0.8	
PT	mm	1.7 ± 0.60	
TF	gf	60 ± 10	
OF	gf	50 ± 10	Min
ОТ	mm	0.7	Max
MD	mm	0.6	
TT	mm	3.6 ± 0.6	

11.Precaution

11.1 Immersion Soldering condition

ITEM	CONDITION
Preheat temperature	110°C Max (Ambient temperature of soldering surface of P.W.B)
Preheat time	60s, Max
Area of flux	1/2 Max of PWB Thickness
Temperature of solder	260±5°C
Time of immersion	Within 5s
Number of soldering	2time Max (But should down heat of the first soldering)
Printed wiring board	Single side copper-clad laminates

- (1) After switches were soldered, please be careful not to clean switches with solvent
- (2) Under the condition of using soldering iron, soldering temperature shall be 350°C max within 3 sec.

11.2 Notes

- (1) Please be cautious not to give excessive static load or shock to switches.
- (2) Please be careful not to stack up P. W. B. after switches were soldered.
- (3) Preservation under high temperature and high humidity or corrosive gas should be avoided Especially. When you need to preserve for a long period, do not open the carton.
- (4) Products meet the ROHS & REACH environmental management substances control standards.